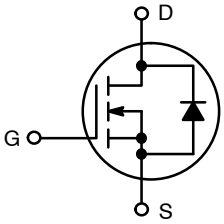
# MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

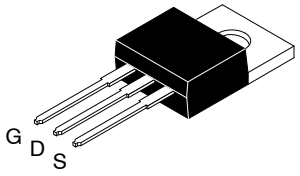
## 650 V, 12 A, 260 mΩ

# FCP260N65S3

| $V_{DSS}$ | $R_{DS(ON)}$ MAX | $I_D$ MAX |
|---|---|---|
| 650 V | 260 mΩ @ 10 V | 12 A |




**POWER MOSFET**




**TO−220**
**CASE 340AT**

### Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

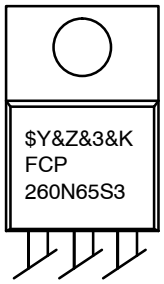
### Features

- 700 V @ $T_J$ = 150°C
- Typ. $R_{DS(on)}$ = 222 mΩ
- Ultra Low Gate Charge (Typ. $Q_g$ = 24 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 248 pF)
- 100% Avalanche Tested
- These Devices are Pb−Free and are RoHS Compliant

### Applications

- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter

### MARKING DIAGRAM




| | |
|---|---|
| $Y | = **onsemi** Logo |
| &Z | = Assembly Plant Code |
| &3 | = Numeric Date Code |
| &K | = Lot Code |
| FCP260N65S3 | = Specific Device Code |

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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## ABSOLUTE MAXIMUM RATINGS ($T_C$ = 25°C, Unless otherwise specified)

| Symbol | Parameter | | Value | Unit |
|---|---|---|---|---|
| $V_{DSS}$ | Drain to Source Voltage | | 650 | V |
| $V_{GSS}$ | Gate to Source Voltage | DC | ±30 | V |
| | | AC (f > 1 Hz) | ±30 | V |
| $I_D$ | Drain Current | Continuous ($T_C$ = 25°C) | 12 | A |
| | | Continuous ($T_C$ = 100°C) | 7.6 | |
| $I_{DM}$ | Drain Current | Pulsed (Note 1) | 30 | A |
| $E_{AS}$ | Single Pulsed Avalanche Energy (Note 2) | | 57 | mJ |
| $I_{AS}$ | Avalanche Current (Note 1) | | 2.3 | A |
| $E_{AR}$ | Repetitive Avalanche Energy (Note 1) | | 0.9 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 20 | |
| $P_D$ | Power Dissipation | ($T_C$ = 25°C) | 90 | W |
| | | Derate Above 25°C | 0.72 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | −55 to +150 | °C |
| $T_L$ | Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 s | | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. $I_{AS}$ = 2.3 A, $R_G$ = 25 Ω, starting $T_J$ = 25°C.
3. $I_{SD}$ ≤ 6 A, di/dt ≤ 200 A/μs, $V_{DD}$ ≤ 400 V, starting $T_J$ = 25°C.

## THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 1.39 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | |

## PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Marking | Package | Packing Method | Reel Size | Tape Width | Quantity |
|---|---|---|---|---|---|---|
| FCP260N65S3 | FCP260N65S3 | TO−220 | Tube | N/A | N/A | 50 Units |



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**ELECTRICAL CHARACTERISTICS** ($T_C$ = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | | |
| $BV_{DSS}$ | Drain to Source Breakdown Voltage | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C | 650 | | | V |
| | | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C | 700 | | | V |
| $\Delta BV_{DSS}/\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 1 mA, Referenced to 25°C | | 0.66 | | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 650 V, $V_{GS}$ = 0 V | | | 1 | μA |
| | | $V_{DS}$ = 520 V, $T_C$ = 125°C | | 0.77 | | |
| $I_{GSS}$ | Gate to Body Leakage Current | $V_{GS}$ = ±30 V, $V_{DS}$ = 0 V | | | ±100 | nA |
| **ON CHARACTERISTICS** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$ = $V_{DS}$, $I_D$ = 0.29 mA | 2.5 | | 4.5 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS}$ = 10 V, $I_D$ = 6 A | | 222 | 260 | mΩ |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 20 V, $I_D$ = 6 A | | 7.4 | | S |
| **DYNAMIC CHARACTERISTICS** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz | | 1010 | | pF |
| $C_{oss}$ | Output Capacitance | | | 25 | | pF |
| $C_{oss(eff.)}$ | Effective Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 248 | | pF |
| $C_{oss(er.)}$ | Energy Related Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 33 | | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10 V | $V_{DS}$ = 400 V, $I_D$ = 6 A, $V_{GS}$ = 10 V (Note 4) | | 24 | | nC |
| $Q_{gs}$ | Gate to Source Gate Charge | | | 6.1 | | nC |
| $Q_{gd}$ | Gate to Drain “Miller” Charge | | | 9.7 | | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | | 8.7 | | Ω |
| **SWITCHING CHARACTERISTICS** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 400 V, $I_D$ = 6 A, $V_{GS}$ = 10 V, $R_g$ = 4.7 Ω (Note 4) | | 18 | | ns |
| $t_r$ | Turn-On Rise Time | | | 18 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 49 | | ns |
| $t_f$ | Turn-Off Fall Time | | | 12 | | ns |
| **SOURCE-DRAIN DIODE CHARACTERISTICS** | | | | | | |
| $I_S$ | Maximum Continuous Source to Drain Diode Forward Current | | | | 12 | A |
| $I_{SM}$ | Maximum Pulsed Source to Drain Diode Forward Current | | | | 30 | A |
| $V_{SD}$ | Source to Drain Diode Forward Voltage | $V_{GS}$ = 0 V, $I_{SD}$ = 6 A | | | 1.2 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{DD}$ = 400 V, $I_{SD}$ = 6 A, $dI_F/dt$ = 100 A/μs | | 251 | | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | | 3.4 | | μC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.



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## TYPICAL PERFORMANCE CHARACTERISTICS

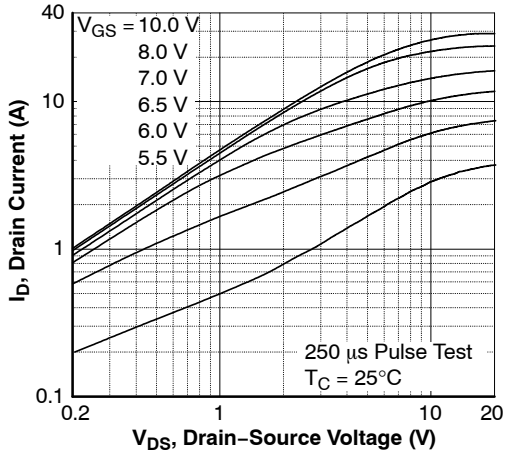



**Figure 1. On−Region Characteristics**

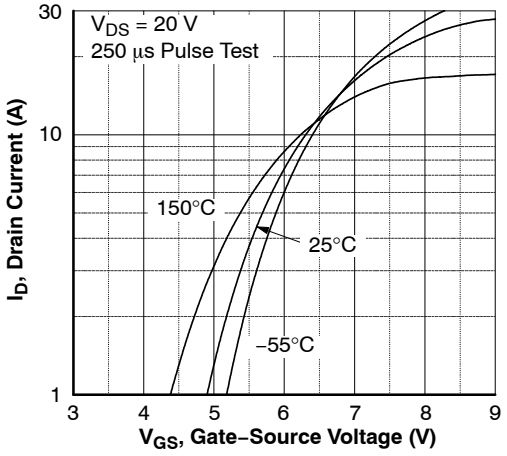



**Figure 2. Transfer Characteristics**

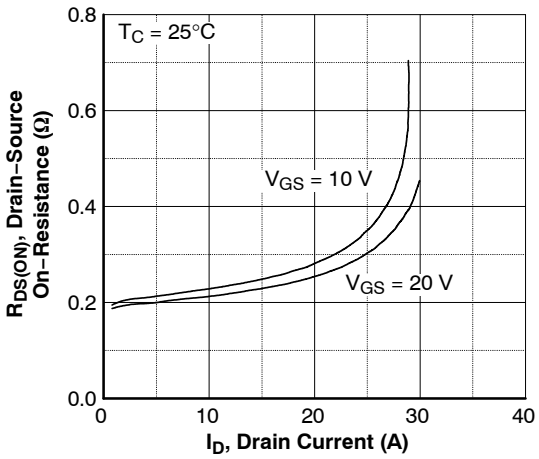



**Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage**

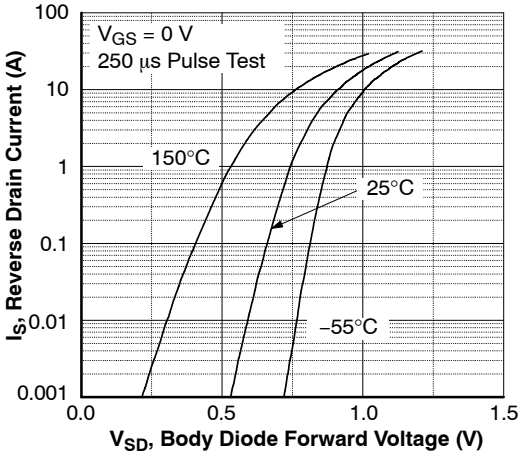



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

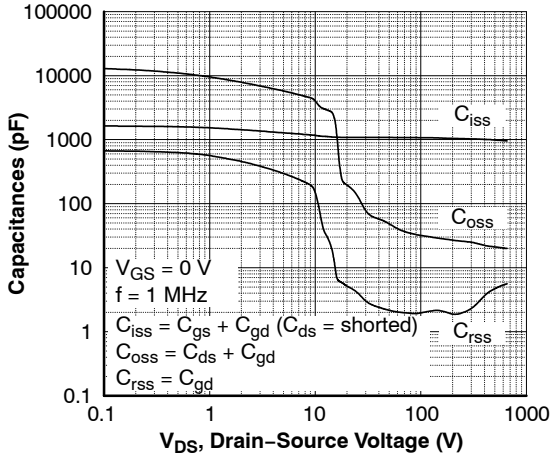



**Figure 5. Capacitance Characteristics**

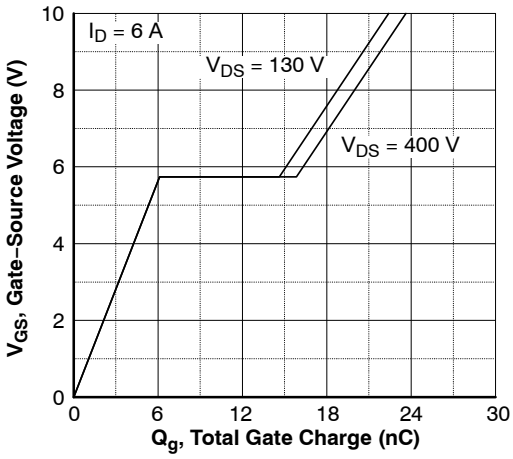



**Figure 6. Gate Charge Characteristics**



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## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

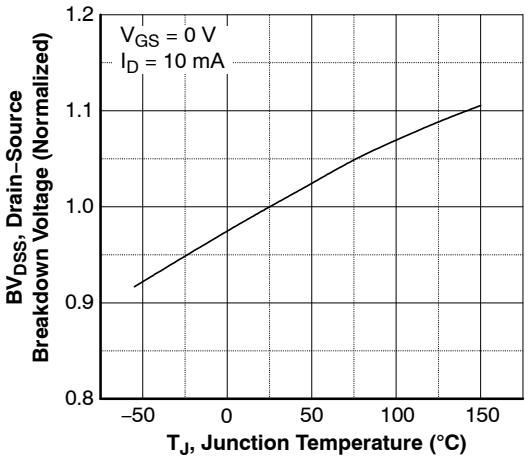



**Figure 7. Breakdown Voltage Variation vs. Temperature**

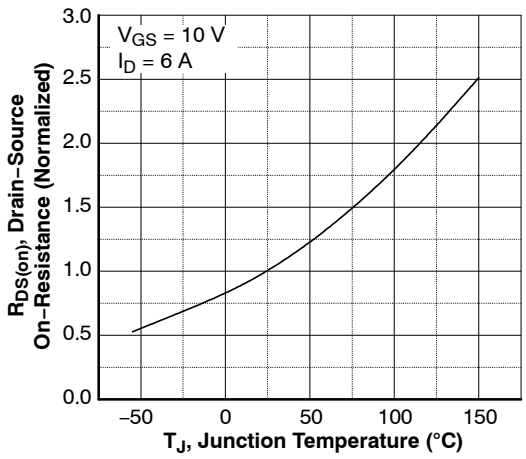



**Figure 8. On−Resistance Variation vs. Temperature**

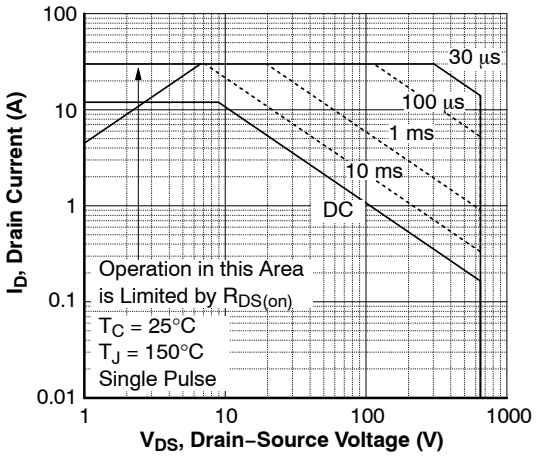



**Figure 9. Maximum Safe Operating Area**

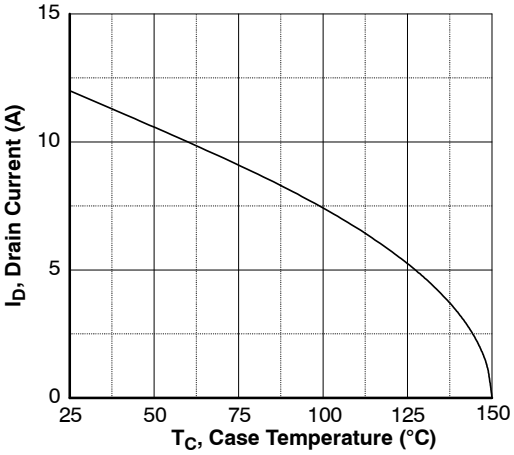



**Figure 10. Maximum Drain Current vs. Case Temperature**

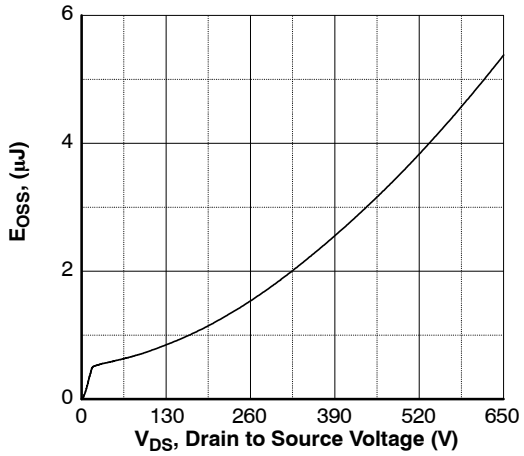



**Figure 11. $E_{OSS}$ vs. Drain to Source Voltage**



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## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

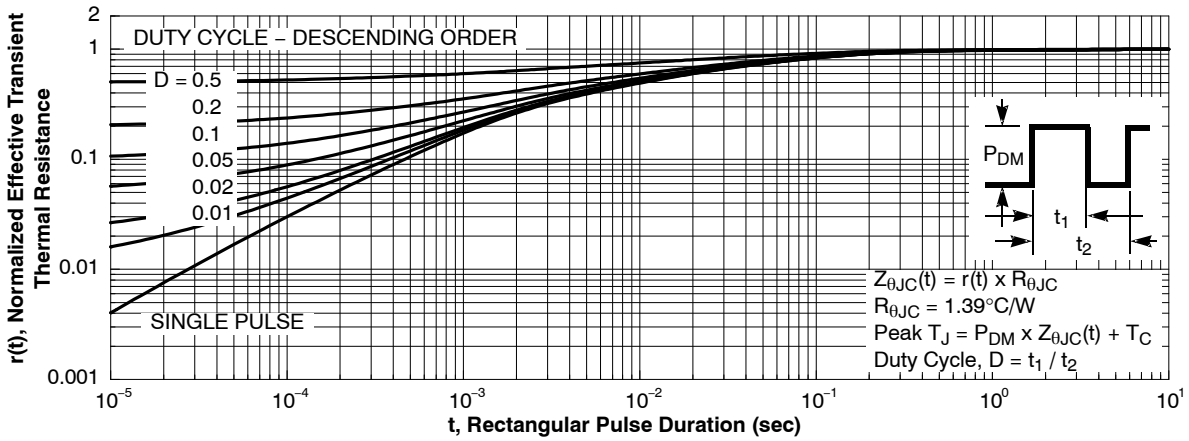



**Figure 12. Transient Thermal Response Curve**



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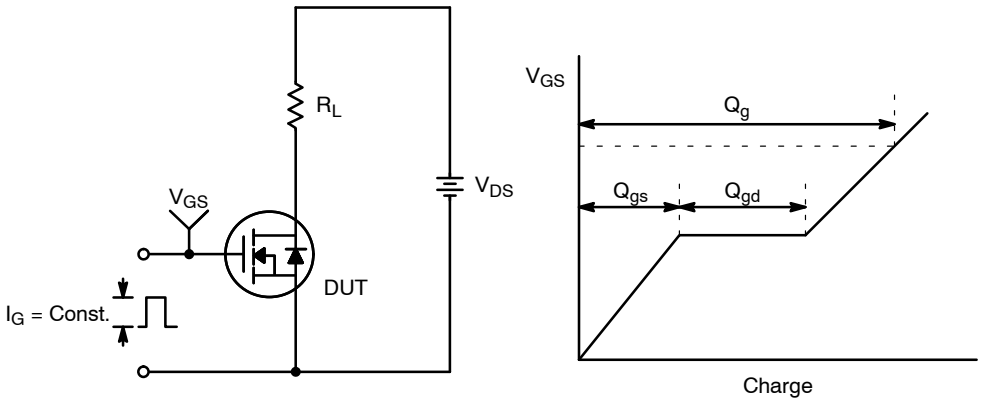



**Figure 13. Gate Charge Test Circuit & Waveform**

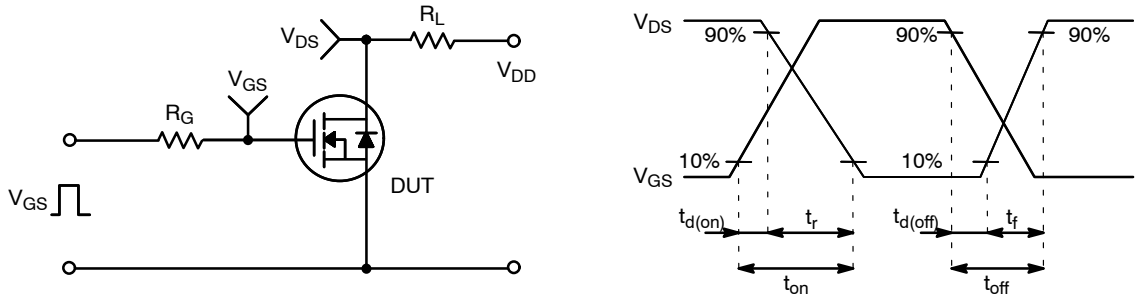



**Figure 14. Resistive Switching Test Circuit & Waveforms**

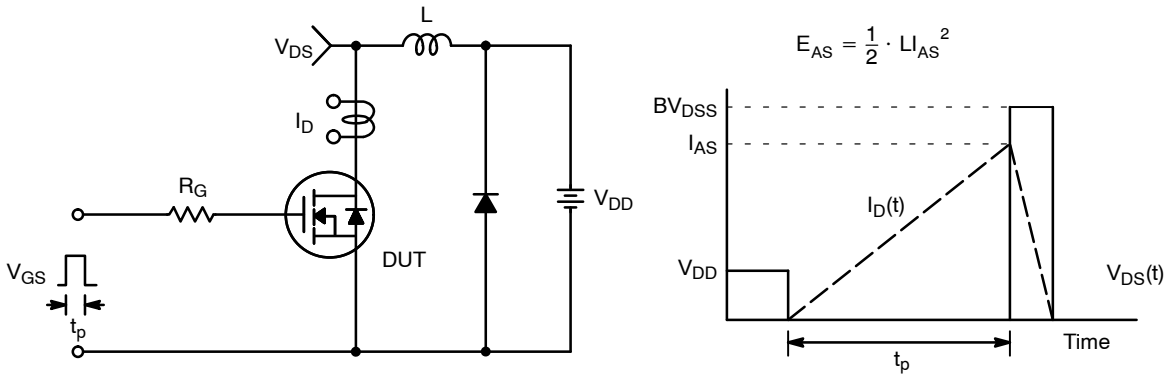



**Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms**



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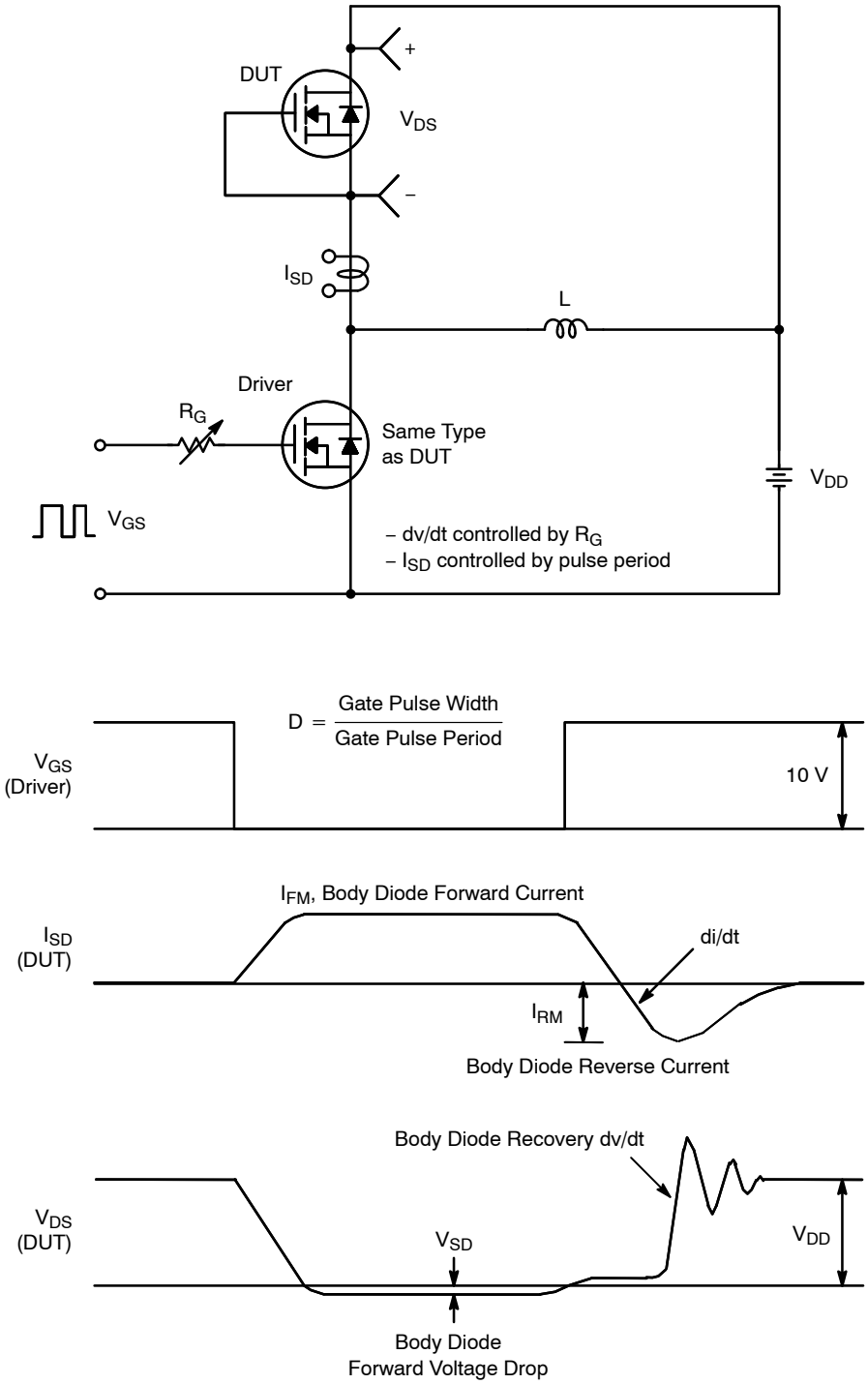
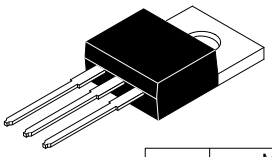



**Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms**

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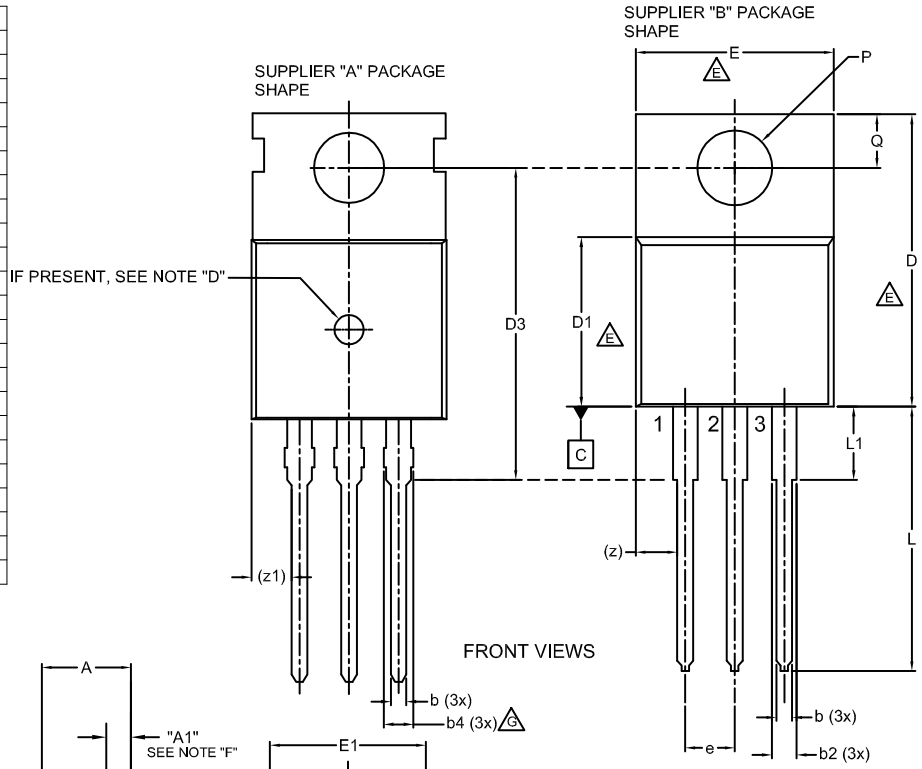
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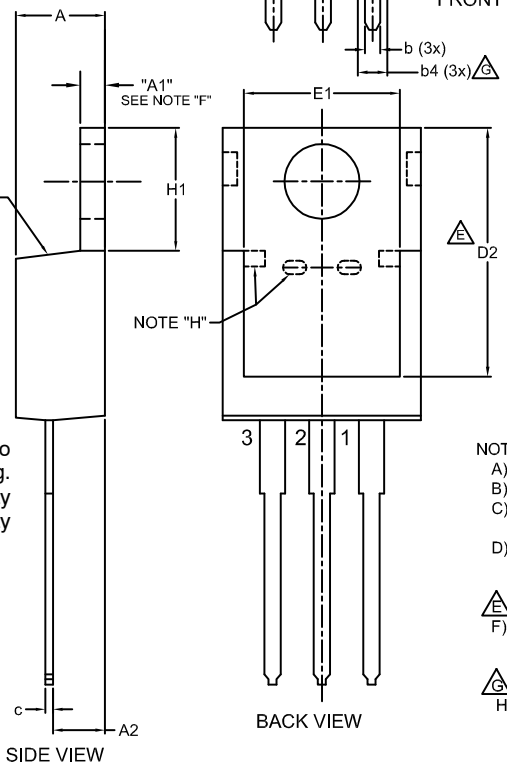


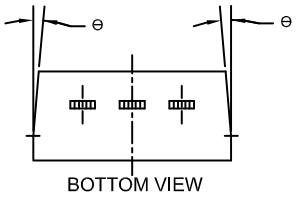
**TO−220−3LD**
CASE 340AT
ISSUE B

DATE 08 AUG 2022

| DIM | MILLIMETERS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | 4.00 | -- | 4.70 |
| A1 | SEE NOTE "F" | | |
| A2 | 2.10 | -- | 2.85 |
| b | 0.55 | -- | 1.00 |
| b2 | 1.10 | -- | 1.62 |
| b4 | 1.42 | -- | 1.62 |
| c | 0.36 | -- | 0.60 |
| D | 13.90 | -- | 16.30 |
| D1 | 8.13 | -- | 9.40 |
| D2 | 11.50 | -- | 14.30 |
| D3 | 15.42 | -- | 16.51 |
| E | 9.65 | -- | 10.67 |
| E1 | 7.59 | -- | 8.65 |
| e | 2.40 | -- | 2.67 |
| H1 | 6.06 | -- | 6.69 |
| L | 12.70 | -- | 14.04 |
| L1 | 2.70 | -- | 4.10 |
| P | 3.50 | -- | 4.00 |
| Q | 2.50 | -- | 3.40 |
| z | 2.13 REF | | |
| z1 | 2.06 REF | | |
| Θ | 3° | – | 5° |




**GENERIC MARKING DIAGRAM***




XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

NOTES:
A) REFERENCE JEDEC, TO-220, VARIATION AB
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS COMMON TO ALL PACKAGE SUPPLIERS EXCEPT WHERE NOTED [ ].
D) LOCATION OF MOLDED FEATURE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE)
E) DOES NOT COMPLY JEDEC STANDARD VALUE.
F) "A1" DIMENSIONS AS BELOW:
SINGLE GAUGE = 0.51 - 0.61
DUAL GAUGE = 1.10 - 1.45
G) PRESENCE IS SUPPLIER DEPENDENT
H) SUPPLIER DEPENDENT MOLD LOCKING HOLES IN HEATSINK.

| | | |
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**ONLINE SUPPORT**: www.onsemi.com/support
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ENTEGRECİ

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# Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

### Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

**www.entegreci.com**

### Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

**Kategorilere göz atın**

### Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

**Üreticileri görün**

### Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

**Teklif isteyin**

**www.entegreci.com** | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.